

# NCEP40T11G

# NCE N-Channel Super Trench Power MOSFET

#### Description

The NCEP40T11G uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of  $R_{DS(ON)}$  and  $Q_g$ . This device is ideal for high-frequency switching and synchronous rectification.

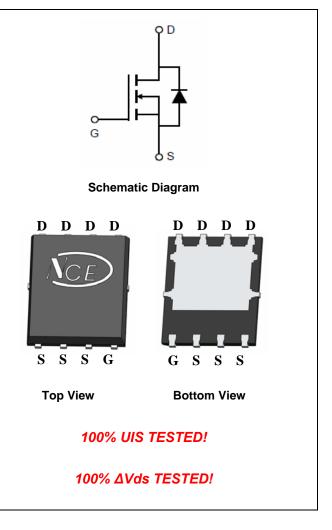
#### **General Features**

V<sub>DS</sub> =40V,I<sub>D</sub> =110A
R<sub>DS(ON)</sub>=2.4mΩ (typical) @ V<sub>GS</sub>=10V
R<sub>DS(ON)</sub>=3.3mΩ (typical) @ V<sub>GS</sub>=4.5V

- Excellent gate charge x R<sub>DS(on)</sub> product(FOM)
- Very low on-resistance R<sub>DS(on)</sub>
- 150 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

### Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification



### Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEP40T11G	NCEP40T11G	DFN5X6-8L	-	-	-

#### Absolute Maximum Ratings (T<sub>c</sub>=25<sup>°</sup>C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	40	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Drain Current-Continuous (Silicon Limited)	Ι <sub>D</sub>	110	А
Drain Current-Continuous(Tc=100℃)	I <sub>D</sub> (100℃)	77.8	А
Pulsed Drain Current (Package Limited)	I <sub>DM</sub>	340	А
Maximum Power Dissipation	PD	75	W
Derating factor		0.6	W/°C
Single pulse avalanche energy (Note 5)	E <sub>AS</sub>	500	mJ
Operating Junction and Storage Temperature Range	T <sub>J</sub> ,T <sub>STG</sub>	-55 To 150	°C







#### **Thermal Characteristic**

Thermal Resistance, Junction-to-Case <sup>(Note 2)</sup>	R <sub>θJC</sub>	1.67	°C/W
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#### **Electrical Characteristics (Tc=25**°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics			-			
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250µA	40		-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =40V,V <sub>GS</sub> =0V	-	-	1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	$V_{GS}$ =±20V, $V_{DS}$ =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$	1.2	1.7	2.2	V
Durain Course On Chata Desistance	P	V <sub>GS</sub> =10V, I <sub>D</sub> =55A	-	2.4	2.8	mΩ
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =55A	-	3.3	3.9	mΩ
Forward Transconductance	<b>g</b> fs	V <sub>DS</sub> =5V,I <sub>D</sub> =55A	-	60	-	S
Dynamic Characteristics (Note4)	····					
Input Capacitance	C <sub>lss</sub>		-	3510	4200	PF
Output Capacitance	Coss	V <sub>DS</sub> =20V,V <sub>GS</sub> =0V, F=1.0MHz	-	860	1000	PF
Reverse Transfer Capacitance	C <sub>rss</sub>	F=1.0WHZ	-	60	78	PF
Switching Characteristics (Note 4)						L
Turn-on Delay Time	t <sub>d(on)</sub>		-	10.5	-	nS
Turn-on Rise Time	tr	V <sub>DD</sub> =20V,I <sub>D</sub> =55A	-	4	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =10V, $R_{G}$ =1.6 $\Omega$	-	35	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	5	-	nS
Total Gate Charge	Qg		-	60	72	nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}=20V, I_{D}=55A,$	-	9.9		nC
Gate-Drain Charge	Q <sub>gd</sub>	V <sub>GS</sub> =10V	-	9.5		nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =55A	-		1.2	V
Diode Forward Current (Note 2)	Is		-	-	110	А
Reverse Recovery Time	t <sub>rr</sub>	$T_J$ = 25°C, $I_F$ = $I_S$	-		24	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs <sup>(Note3)</sup>	-		68	nC

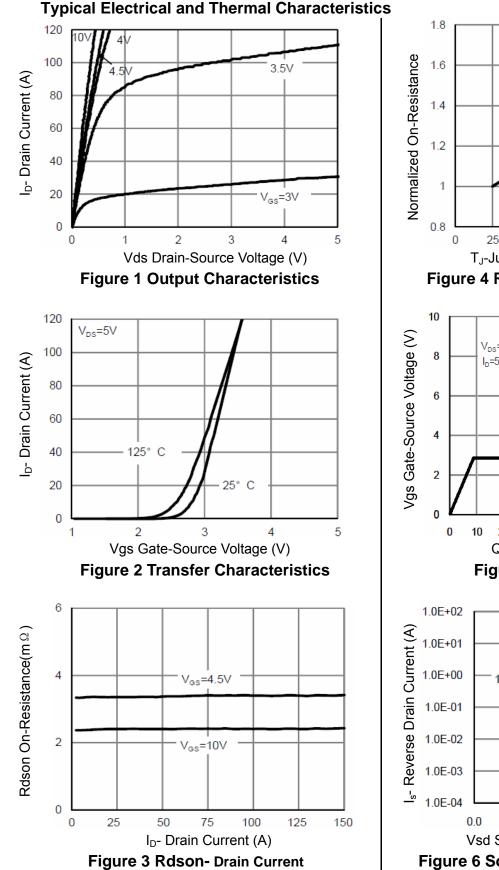
#### Notes:

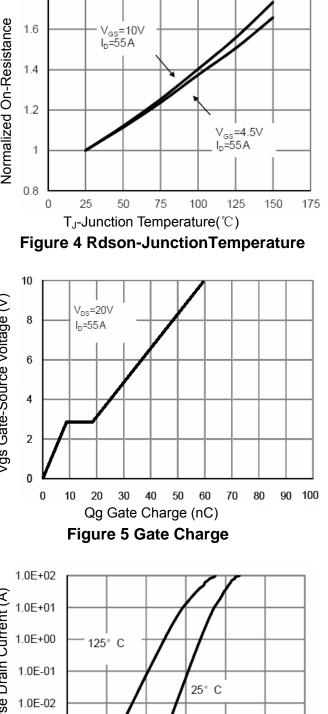
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t  $\leq$  10 sec.
- 3. Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25  $^\circ \!\! C$  ,V\_{DD}=20V,V\_G=10V,L=0.5mH,Rg=25  $\!\Omega$



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0.4

0.6

0.8

1.0

1.2

0.2



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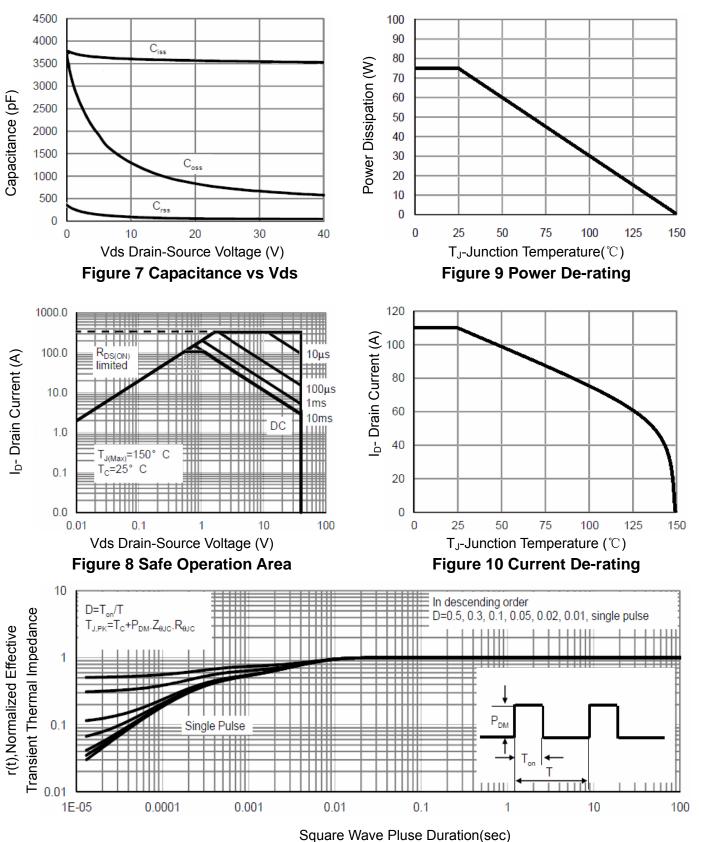


Figure 11 Normalized Maximum Transient Thermal Impedance

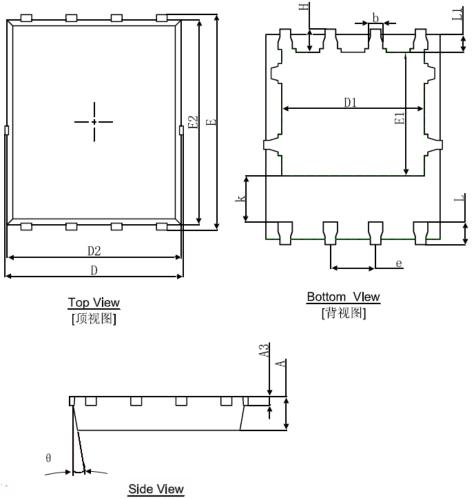


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Pb Free Product

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## **DFN5X6-8L Package Information**



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1.524	1/14	J

Cumela e l	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
A	0.900	1.000	0.035	0.039	
A3	0.254REF.		0.010	REF.	
D	4.944	5.096	0.195	0.201	
E	5.974	6.126	0.235	0.241	
D1	3.910	4.110	0.154	0.162	
E1	3.375	3.575	0.133	0.141	
D2	4.824	4.976	0.190	0.196	
E2	5.674	5.826	0.223	0.229	
k	1.190	1.390	0.047	0.055	
b	0.350	0.450	0.014	0.018	
e	1.270TYP.		0.050	TYP.	
L	0.559	0.711	0.022	0.028	
L1	0.424	0.576	0.017	0.023	
Н	0.574	0.726	0.023	0.029	
θ	8°	12°	8°	12°	







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